

*IGBT* 

# FMG1G400US60L

# **Molding Type Module**

## **General Description**

Fairchild IGBT Power Module provides low conduction and switching losses as well as short circuit ruggedness. It's designed for the applications such as motor control, uninterrupted power supplies (UPS) and general inverters where short-circuit ruggedness is required.

## **Features**

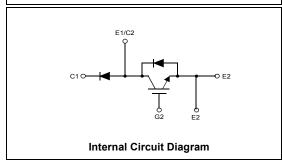
- Short Circuit Rated Time; 10us @  $T_C = 100$ °C,  $V_{GE} = 15V$
- · High Speed Switching
- Low Saturation Voltage : V<sub>CE</sub>(sat) = 2.1 V @ I<sub>C</sub> = 400A
- High Input Impedance
- Fast & Soft Anti-Parallel FWD
- · UL Certified No.E209204

# **Application**

- AC & DC Motor Controls
- · General Purpose Inverters
- Robotics
- · Servo Controls
- UPS



Package Code: 7PM-IA



# **Absolute Maximum Ratings** T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Description		FMG1G400US60L	Units
V <sub>CES</sub>	Collector-Emitter Voltage		600	V
V <sub>GES</sub>	Gate-Emitter Voltage		± 20	V
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 80°C	400	А
I <sub>CM (1)</sub>	Pulsed Collector Current		800	Α
I <sub>F</sub>	Diode Continuous Forward Current	@ T <sub>C</sub> = 80°C	400	Α
I <sub>FM</sub>	Diode Maximum Forward Current		800	Α
$P_{D}$	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	1136	W
T <sub>SC</sub>	Short Circuit Withstand Time	@ T <sub>C</sub> = 100°C	10	us
T <sub>J</sub>	Operating Junction Temperature		-40 to +150	°C
T <sub>STG</sub>	Storage Temperature Range		-40 to +125	°C
V <sub>ISO</sub>	Isolation Voltage	@ AC 1minute	2500	V
Mounting Torque	Power Terminal Screw : M6		4.0	N.m
Mounting Torque	Mounting Screw : M6		4.0	N.m

#### Notes

(1) Repetitive rating : Pulse width limited by max. junction temperature

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250uA$	600			V
ΔB <sub>VCES</sub> / ΔT <sub>J</sub>	Temperature Coeff. of Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 1mA		0.6		V/°C
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	uA
I <sub>GES</sub>	Gate - Emitter Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA

## **On Characteristics**

V <sub>GE(th)</sub>	Gate - Emitter Threshold Voltage	$I_C$ = 400mA, $V_{CE}$ = $V_{GE}$	5.0	6.5	8.5	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	$I_C = 400A$ , $V_{GE} = 15V$		2.1	2.7	V

# **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time			160		ns
t <sub>r</sub>	Rise Time	V 000 V I 400 A		220	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{CC} = 300 \text{ V}, I_C = 400 \text{A},$		230	-	ns
t <sub>f</sub>	Fall Time	$R_G = 2\Omega$ , $V_{GE} = 15V$ , Inductive Load, $T_C = 25^{\circ}C$		150	250	ns
t <sub>f</sub> E <sub>on</sub>	Turn-On Switching Loss	middelive Load, 1 <sub>C</sub> = 25 C		9.5		mJ
E <sub>off</sub>	Turn-Off Switching Loss			21	-	mJ
t <sub>d(on)</sub>	Turn-On Delay Time			320	-	ns
t <sub>r</sub>	Rise Time	V 000 V I 400 A		240	-	ns
$t_{d(off)}$	Turn-Off Delay Time	$V_{CC} = 300 \text{ V, } I_C = 400 \text{A,}$		290	-	ns
t <sub>f</sub>	Fall Time	$R_G = 2\Omega$ , $V_{GE} = 15V$ , Inductive Load, $T_C = 125$ °C		230	-	ns
t <sub>f</sub> E <sub>on</sub>	Turn-On Switching Loss	inductive Load, 1 <sub>C</sub> = 123 G		11	-	mJ
E <sub>off</sub>	Turn-Off Switching Loss			26	-	mJ
T <sub>sc</sub>	Short Circuit Withstand Time	$V_{CC} = 300 \text{ V}, V_{GE} = 15 \text{V}$ @ $T_{C} = 100^{\circ}\text{C}$	10			us
$Q_q$	Total Gate Charge			1200	-	nC
Q <sub>ae</sub>	Gate-Emitter Charge	$V_{CE} = 300 \text{ V}, I_{C} = 400 \text{A},$		310	-	nC
Q <sub>g</sub> Q <sub>ge</sub> Q <sub>gc</sub>	Gate-Collector Charge	V <sub>GE</sub> = 15V		490	-	nC

# Electrical Characteristics of DIODE $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Condi	tions	Min.	Тур.	Max.	Units
· · · · · · · · · · · · · · · · · · ·	Diode Forward Voltage	I <sub>E</sub> = 400A	T <sub>C</sub> = 25°C		1.9	2.8	V
$V_{FM}$		1 <sub>F</sub> = 400A	T <sub>C</sub> = 100°C		1.8		
+	t Diada Dayarra Dagayary Tima		T <sub>C</sub> = 25°C		90	130	no
t <sub>rr</sub> Diode Reverse R	Diode Reverse Recovery Time	Recovery fille	T <sub>C</sub> = 100°C		130		ns
1	Diode Peak Reverse Recovery Current	I <sub>F</sub> = 400A	T <sub>C</sub> = 25°C		35	46	Α
'rr		Current di / dt = 800 A/us $T_C$ =	T <sub>C</sub> = 100°C		76		_ ^
Q <sub>rr</sub>	Diode Reverse Recovery Charge	Diada Dayaraa Daaayary Charga	T <sub>C</sub> = 25°C		1580	3000	nC
			T <sub>C</sub> = 100°C		4940		nC

# **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
$R_{\theta JC}$	Junction-to-Case (IGBT Part, per 1/2 Module)		0.11	°C/W
$R_{\theta JC}$	Junction-to-Case (DIODE Part, per 1/2 Module)		0.18	°C/W
$R_{\theta JC}$	Case-to-Sink (Conductive grease applied)	0.03		°C/W
Weight	Weight of Module	360		g

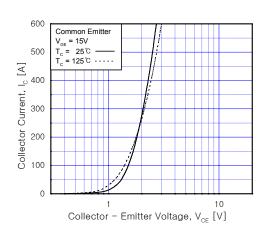


Fig 1. Typical Output Characteristics

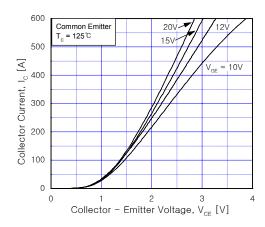


Fig 3. Typical Saturation Voltage Characteristics

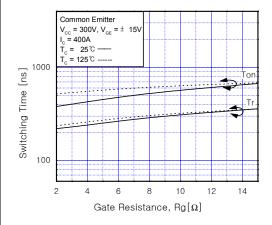


Fig 5. Turn-On Characteristics vs.
Gate Resistance

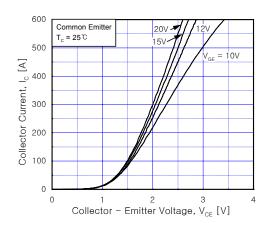


Fig 2. Typical Saturation Voltage Characteristics

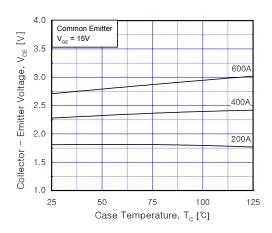


Fig 4. Saturation Voltage vs. Case Temperature at Variant Current Level

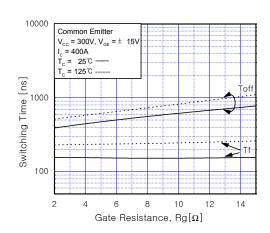


Fig 6. Turn-Off Characteristics vs.
Gate Resistance

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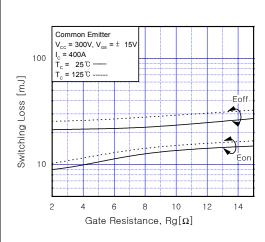


Fig 7. Switching Loss vs. Gate Resistance

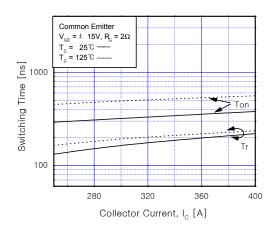


Fig 8. Turn-On Characteristics vs. Collector Current

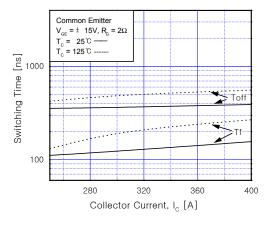


Fig 9. Turn-Off Characteristics vs. Collector Current

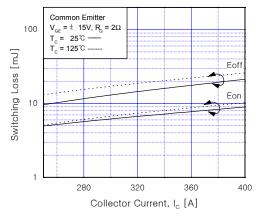


Fig 10. Switching Loss vs. Collector Current

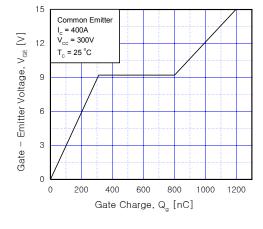


Fig 11. Gate Charge Characteristics

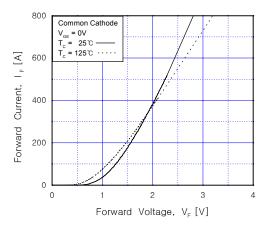


Fig 12. Forward Characteristics (diode)

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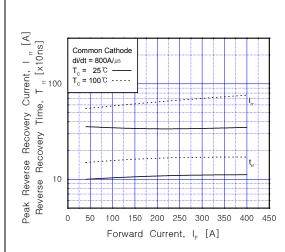
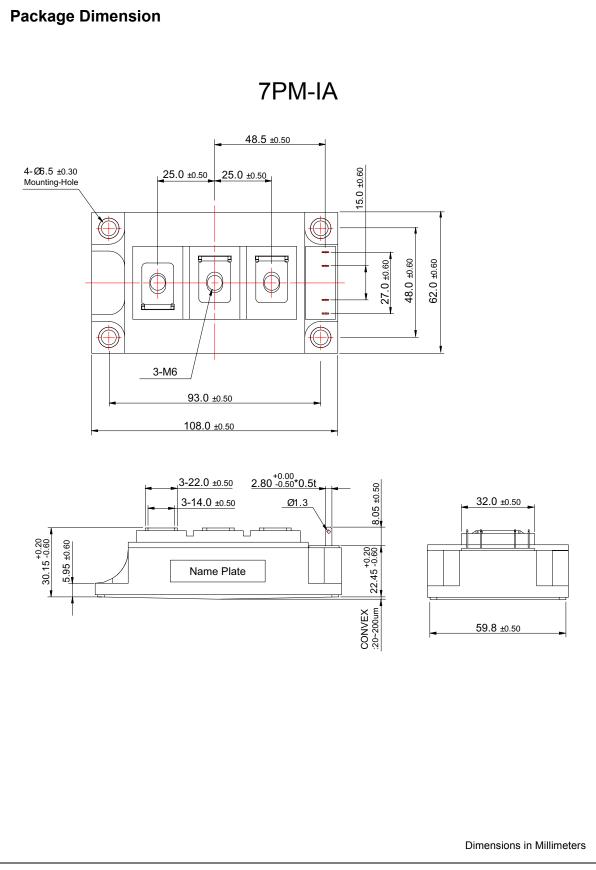


Fig 13. Reverse Recovery Characteristics(diode)



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